



# Product Change Notification

**Change Notification #:** 117435 - 00  
**Change Title:** Intel® ISDN Chipset for Terminals SB21150,  
PCN 117435-00, Transport Media,  
Carrier Tape & Cover Tape Change  
**Date of Publication:** February 24, 2020

## Key Characteristics of the Change:

Transport Media

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	July 6, 2020
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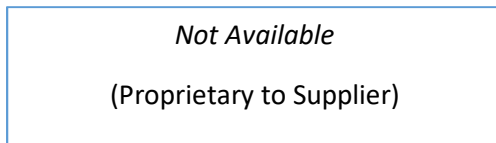
## Description of Change to the Customer:

Due to end of life of tooling for the current carrier tape, Intel will replace and qualify a new carrier tape and new cover tape for the product listed in the Products Affected / Intel Ordering Codes table below.

Current Carrier Tape P/N: MA021563

Current Cover Tape P/N: 3M-26998

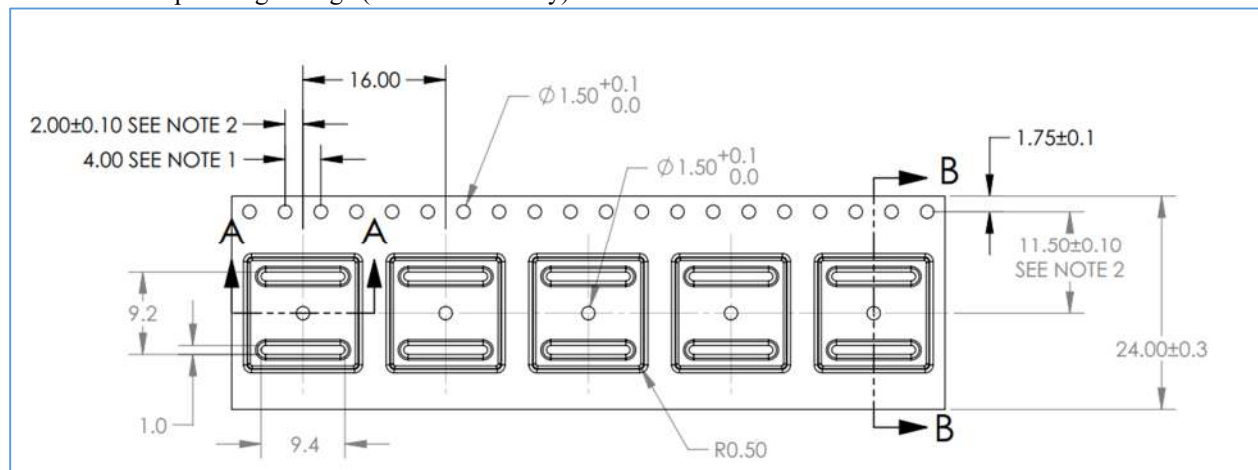
Current Carrier Tape Design Image:



New Carrier Tape P/N: 500399869

New Cover Tape P/N: 500177726/500066311

New Carrier Tape Design Image (for reference only)\*:



**\*New Carrier Tape Design Drawing Notes:**

1. 10 SPROCKET HOLD PITCH CUMULATIVE TOLERANCE  $\pm 0.2$
2. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE.
3. A<sub>o</sub> AND B<sub>o</sub> ARE CALCULATED ON A PLANE AT A DISTANCE "R" ABOVE THE BOTTOM OF THE POCKET.

**Customer Impact of Change and Recommended Action:**

There is no change which will have an impact on product performance, appearance, quality, reliability, interchange ability, functionality, or customer handling and manufacturability. However, there is a supplier change (due to EOL of tooling at current supplier), on both the carrier tape & cover tape resulting in a decrease total quantity per reel, evident at the customer site. The quantity per reel will decrease from 1900 to 1700.

Intel will deplete inventory on the current carrier tape and cover tape before using the new carrier tape and cover tape. Customers will see a mixture until all inventory is depleted.

Please contact your Intel representative for any questions or concerns.

**Products Affected / Intel Ordering Codes:**

Marketing Name	Product Code	S-Spec	MM#
Intel® ISDN Chipset for Terminals PSB211	PSB21150F	S LLHR	947051

**PCN Revision History:**

<b>Date of Revision:</b> February 24, 2020	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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